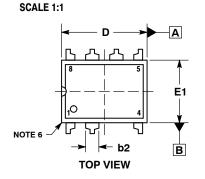


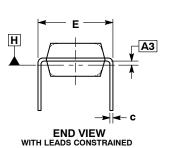


PDIP8 LESS PIN 3

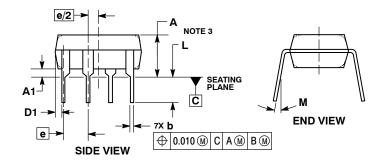
CASE 626AS **ISSUE O**

DATE 23 OCT 2015





NOTE 5



NOTES

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: INCHES.
 DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACK-2. 3.
- DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
- DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
 PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.155	0.175	3.94	4.45
A1	0.020	0.040	0.51	1.02
АЗ	0.015 BSC		0.38 BSC	
b	0.015	0.020	0.38	0.50
b2	0.056	0.064	1.42	1.63
С	0.008	0.012	0.20	0.30
D	0.365	0.369	9.27	9.37
D1	0.005	0.080	0.13	2.03
Е	0.300	0.325	7.62	8.25
E1	0.244	0.260	6.20	6.60
е	0.100 BSC		2.54 BSC	
L	0.115	0.135	2.92	3.43
М		10°		10°

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code = Assembly Location

WL = Wafer Lot YY = Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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